506450552 01/14/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6497323

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
BYUNG JOON HAN	03/31/2016
IL KWON SHIM	03/31/2016
KYOUNGHEE PARK	03/31/2016
YAOJIAN LIN	03/31/2016
KYOWANG KOO	03/31/2016
IN SANG YOON	03/31/2016
SEUNGYONG CHAI	03/31/2016
SUNGWON CHO	03/31/2016
SUNGSOO KIM	03/31/2016
HUN TEAK LEE	03/31/2016
DEOKKYUNG YANG	03/31/2016

#### **RECEIVING PARTY DATA**

Name:	STATS CHIPPAC LTD.
Street Address:	10 ANG MO KIO STREET 65
Internal Address:	#04-08/09 TECHPOINT
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	569059

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16005348

#### **CORRESPONDENCE DATA**

(650)670-8813 Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6506708800

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**Correspondent Name:** WONG & REES LLP

Address Line 1: 4340 STEVENS CREEK BLVD., SUITE 106

Address Line 4: SAN JOSE, CALIFORNIA 95129

PATENT -

REEL: 054925 FRAME: 0140 506450552

ATTORNEY DOCKET NUMBER:	70027-2285	
NAME OF SUBMITTER:	KIRK D. WONG	
SIGNATURE:	/KirkDWong43284/	
DATE SIGNED:	01/14/2021	
Total Attachments: 7		
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PATENT REEL: 054925 FRAME: 0141 Docket No.: 27-960

### **ASSIGNMENT**

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

# INTEGRATED CIRCUIT PACKAGING SYSTEM WITH SHIELDING AND METHOD OF MANUFACTURE THEREOF

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, <u>STATS ChipPAC Ltd.</u>, a Corporation of the <u>Republic of Singapore</u>, having a place of business at 10 Ang Mo Kio Street 65, #04-08/09 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee(s), the receipt of which is hereby acknowledged by said Assignor(s):

- 1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee(s), the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
- 2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee(s) where said Assignee(s) may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee(s).
- 3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee(s), its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
- 4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

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	nd requests the attorney(s) of record in this ing date of this Non Provisional application and it claims priority in the spaces that follow:
Serial Number:15/091,049	Filing Date: 5 April 2016.
Serial Number: 62/146,209	Filing Date: 10 April 2015.
The said Assignor has executed and delivered	I this instrument on the date set forth below.
Byung Joon Han	Date
The said Assignor has executed and delivered  Il Kwon Shim	Date
The said Assignor has executed and delivered	this instrument on the date set forth below.
KyoungHee Park	Date
The said Assignor has executed and delivered	this instrument on the date set forth below.
Yaojian Lin	Date

5. Said Assignor(s) hereby authorizes and requests the attorney(s) of record in this

application to insert the serial number and filing date of this Non Provisional application and that of the Provisional application from which it claims priority in the spaces that follow: Serial Number: \_\_\_\_\_\_15/091,049 Filing Date: \_\_\_\_\_5 April 2016 \_\_\_\_. Serial Number: 62/146.209 Filing Date: 10 April 2015 The said Assignor has executed and delivered this instrument on the date set forth below. Byung Joon Han Date The said Assignor has executed and delivered this instrument on the date set forth below. Il Kwon Shim The said Assignor has executed and delivered this instrument on the date set forth below. KyoungHee Park Date The said Assignor has executed and delivered this instrument on the date set forth below.

Date

Yaojian Lin

application to insert the serial number and filing that of the Provisional application from which it	date of this Non Provisional application a
Serial Number:15/091,049	Filing Date: 5 April 2016.
Serial Number: 62/146,209	Filing Date: 10 April 2015.
The said Assignor has executed and delivered th	is instrument on the date set forth below.
Byung Joon Han	Date
The said Assignor has executed and delivered th	
Il Kwon Shim	Date
The said Assignor has executed and delivered the	is instrument on the date set forth below.
KyoungHee Park  KyoungHee Park	Mar. 31. 2016  Date
The said Assignor has executed and delivered the	is instrument on the date set forth below.
Yaojian Lin	Date

PATENT REEL: 054925 FRAME: 0145 Docket No.: 27-960 ASSIGNMENT

5. Said Assignor(s) hereby authorizes and requests the attorney(s) of record in this

application to insert the serial number and filing date of this Non Provisional application and that of the Provisional application from which it claims priority in the spaces that follow: Serial Number: \_\_\_\_\_\_15/091,049 Filing Date: \_\_\_\_\_5 April 2016 \_\_\_\_\_. Serial Number: 62/146,209 Filing Date: 10 April 2015 The said Assignor has executed and delivered this instrument on the date set forth below. Byung Joon Han Date The said Assignor has executed and delivered this instrument on the date set forth below. Il Kwon Shim Date The said Assignor has executed and delivered this instrument on the date set forth below. KyoungHee Park Date The said Assignor has executed and delivered this instrument on the date set forth below. 3/13/2016

The said Assignor has executed and delivered	I this instrument on the date set forth below.
Toer	Mar. 31, 2016  Date
KyoWang Koo	Date
The said Assignor has executed and delivered	d this instrument on the date set forth below.
15/20	Mar. 31, 2016  Date
In Sang Yoon	Date
The said Assignor has executed and delivered	d this instrument on the date set forth below.
di CY	May 21, Ont
SeungYong Chai	Date
Scung Fong Char	Bute
The said Assignor/has executed and delivere	
	Mar. 31. 2016  Date
SungWon Cho	Date
The said Assignor has executed and delivere	d this instrument on the date set forth below.
71	May. 71 rolf  Date
SungSoo Kim	Date

Docket No.: 27-960

## **ASSIGNMENT**

The said Assignor has executed and delivered the	his instrument on the date se	t forth below.
A	Mar. 31	2016
Hun Teak Lee	Date	
The said Assignor has executed and delivered to	his instrument on the date so	et forth below.
	Mar.	31 20/6
Deok Kyung Vang	Date	

**RECORDED: 01/14/2021**